

AMENDMENTS TO THE SPECIFICATION

Please amend the Abstract as follows:

~~The invention relates to a method~~ Provided are methods for applying a covering layer to a substrate, ~~comprising of including~~ applying an adhesive layer in non-cross-linked state to the substrate and applying thereto a cross-linked covering layer, characterized in that the covering layer is provided with openings, and ~~to-a-method-methods~~ for manufacturing a coating package, and ~~use-of-using~~ the coating package.